



|                  | CPC1906Y | Units            |
|------------------|----------|------------------|
| Blocking Voltage | 60       | V                |
| Load Current     | 2        | A <sub>rms</sub> |
| On-Resistance    | 0.3      | Ω                |

#### **Features**

- Power SIP Package
- Handle Load Currents Up to 2A<sub>rms</sub>
- High Reliability
- No Moving Parts
- Low Drive Power Requirements (TTL/CMOS Compatible)
- Arc-Free With No Snubbing Circuits
- ullet 2500V $_{
  m rms}$  Input/Output Isolation
- No EMI/RFI Generation
- · Machine Insertable, Wave Solderable

# **Applications**

- Industrial Controls
- Motor Control
- Robotics
- · Medical Equipment—Patient/Equipment Isolation
- Instrumentation
  - Multiplexers
  - Data Acquisition
  - Electronic Switching
  - I/O Subsystems
  - Meters (Watt-Hour, Water, Gas)
- IC Equipment
- Home Appliances

### **Description**

Clare and IXYS have combined to bring OptoMOS® technology, reliability and compact size to a new family of high power solid state relays. As part of that family, the CPC1906Y is a 1-Form-A solid state relay. The CPC1906Y employs optically coupled MOSFET technology to provide 2500V<sub>rms</sub> of input to output isolation. The efficient MOSFET switches and photovoltaic die use Clare's patented OptoMOS architecture while the input is controlled by a highly efficient GaAlAs infrared LED. The combination of low on resistance and high load current handling capabilities makes the relay suitable for a variety of high performance switching applications.

### **Approvals**

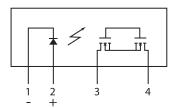
- UL recognized component: File # E69938
- Certified to: UL 508

# **Ordering Information**

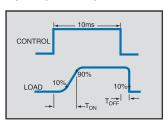
| Part #   | Description                     |  |  |
|----------|---------------------------------|--|--|
| CPC1906Y | Power SIP Package (25 per tube) |  |  |

# **Pin Configuration**

#### **CPC1906Y Pinout**



### Switching Characteristics of Normally Open (Form A) Devices





# **Absolute Maximum Ratings (@ 25° C)**

| Parameter                            | Ratings     | Units            |  |
|--------------------------------------|-------------|------------------|--|
| Blocking Voltage                     | 60          | V                |  |
| Reverse Input Voltage                | 5           | V                |  |
| Input control Current                | 50          | mA               |  |
| Peak (10ms)                          | 1           | А                |  |
| Input Power Dissipation <sup>1</sup> | 150         | mW               |  |
| Isolation voltage Input to Output    | 2500        | V <sub>rms</sub> |  |
| Operational Temperature              | -40 to +85  | °C               |  |
| Storage Temperature                  | -40 to +125 | °C               |  |

<sup>1</sup> Derate Linearly 3.33 mw / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

### **Electrical Characteristics**

| Conditions                                | Symbol  | Min  | Тур   | Max  | Units  |
|---|---|--|---|--|--|
|   | ·   |  |   |  |  |
| free air                                  | IL  | -  | -   | 2  | A <sub>rms</sub>                                       |
| T=10ms                                    | I <sub>LPK</sub>  | -  | -   | 9  | A <sub>rms</sub>                                       |
| I <sub>L</sub> =1A                        | R <sub>ON</sub>   | -  | 0.105   | 0.3  | Ω  |
| V <sub>L</sub> =60V                       | 1   | -  | -   | 1  | μA   |
| I <sub>F</sub> =10mA, V <sub>L</sub> =10V | T <sub>ON</sub>   | -  | 3.5   | 10   | ms   |
| I <sub>F</sub> =10mA, V <sub>L</sub> =10V | T <sub>OFF</sub>  | -  | 0.04  | 5  | ms   |
| 50V, f=1MHz                               |   | -  | 130   | -  | pF   |
|   |   |  | •   |  |  |
| I <sub>L</sub> =1A                        | I <sub>F</sub>  | 10   | -   | -  | mA   |
| -   | I <sub>F</sub>  | 0.6  | -   | -  | mA   |
| I <sub>F</sub> =5mA                       | V <sub>F</sub>  | 0.9  | 1.2   | 1.4  | V  |
| V <sub>R</sub> =5V                        | I <sub>B</sub>  | -  | -   | 10   | μA   |
|   |   |  | ,   |  |  |
| f=1MHz                                    | I <sub>I/O</sub>  | -  | 2   | -  | pF   |
|   | free air $T=10ms$ $I_{L}=1A$ $V_{L}=60V$ $I_{F}=10mA, V_{L}=10V$ $50V, f=1MHz$ $I_{L}=1A$ $I_{L}=1A$ $I_{R}=5mA$ $V_{R}=5V$ | free air  T=10ms  I_LPK  I_L=1A  R_{0N}  V_L=60V  I_LEAK  I_F=10mA, V_L=10V  T_{0N}  I_F=10mA, V_L=10V  T_{0FF}  50V, f=1MHz  C_{0UT}  I_L=1A  I_F  I_F=5mA  V_R=5V  I_L  I_L  I_L  I_L  I_L  I_L  I_L  I_ | free air  T=10ms  I_LPK  I_=1A  R_{0N}  V_=60V  I_{EAK}  I_=10mA, V_=10V  T_{0N}  I_F=10mA, V_=10V  T_{0FF}  50V, f=1MHz  C_{0UT}  I_F=5mA  V_F  0.6  V_F=5V  I_R | $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ |

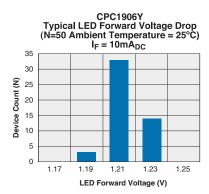
<sup>&</sup>lt;sup>1</sup> Measurement taken within 1 second of on time.

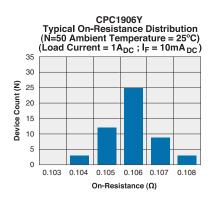
### **Thermal Characteristics**

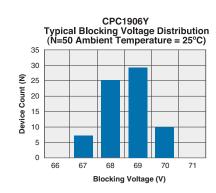
| Parameter                             | Conditions | Symbol          | Min | Тур | Max | Units |
|---------------------------------------|------------|-----------------|-----|-----|-----|-------|
| Thermal Resistance (junction to case) | -          | $R_{\theta JC}$ | -   | 1.5 | -   | °C/W  |

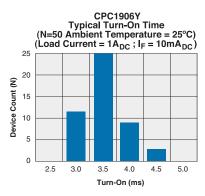


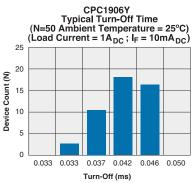
### **PERFORMANCE DATA\***

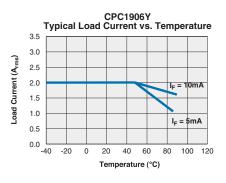


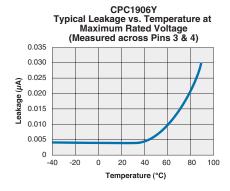


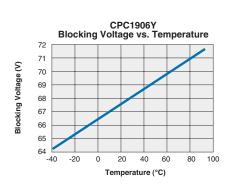


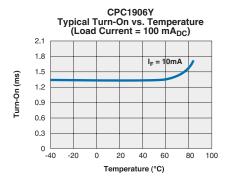


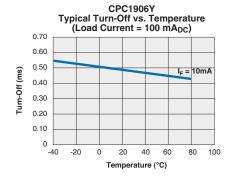


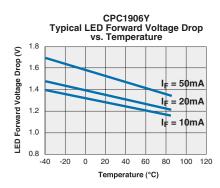


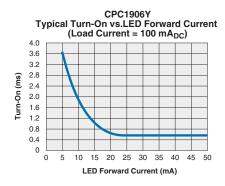








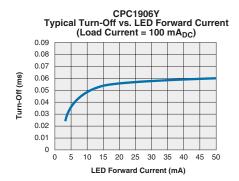


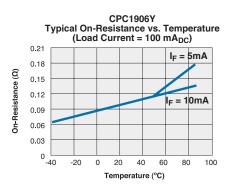


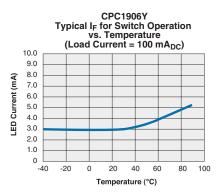
<sup>\*</sup>The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

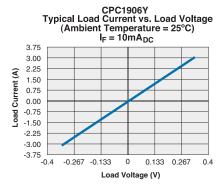


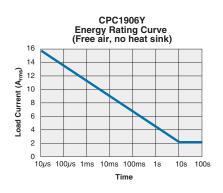
# **PERFORMANCE DATA\***











<sup>\*</sup>The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.



# **Manufacturing Information**

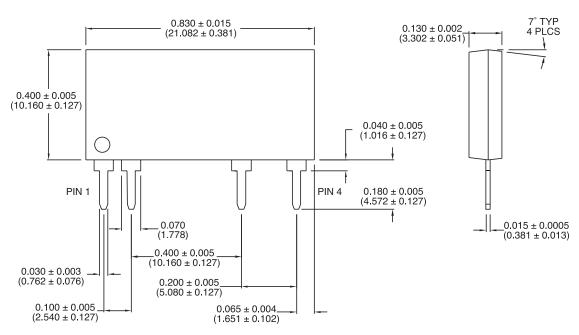
#### Soldering

Recommended soldering processes are limited to 245°C component body temperature for 10 seconds.

#### Washing

Clare does not recommend ultrasonic cleaning or the use of chlorinated solvents.

### **MECHANICAL DIMENSIONS**



Dimensions: inches (mm)

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